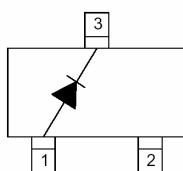


RoHS Compliant Product  
A suffix of "-C" specifies halogen & lead-free

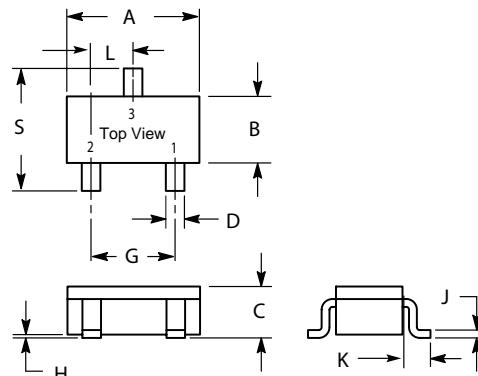
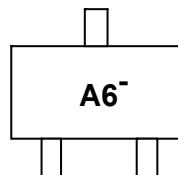
## Description

- \* The SBAS16 is designed for high-speed switching application in hybrid thick and thin-film circuits.
- \* The device is manufactured by the silicon epitaxial planar process and packed in a plastic surface mount package.

Diagram :



Marking



SC-59		
Dim	Min	Max
A	2.70	3.10
B	1.40	1.60
C	1.00	1.30
D	0.35	0.50
G	1.70	2.10
H	0.00	0.10
J	0.10	0.26
K	0.20	0.60
L	0.85	1.15
S	2.40	2.80

All Dimension in mm

## Absolute Maximum Ratings at TA = 25 °C

Parameter	Symbol	Ratings	Unit
Reverse Voltage	V <sub>R</sub>	75	V
Repetitive Reverse Voltage	V <sub>RR</sub>	85	V
Forward Current	I <sub>F</sub>	250	mA
Repetitive Forward Current	I <sub>FR</sub>	500	mA
Forward Surge Current (1ms)	I <sub>FSM</sub>	1000	mW
Total Power Dissipation	P <sub>D</sub>	200	mW
Operating Junction and Storage Temperature Range	T <sub>j</sub> , T <sub>stg</sub>	-65~+150	°C

## Characteristics at TA = 25°C

Characteristic	Symbol	Min.	Max.	Unit	Test Conditions
Reverse Breakdown Voltage	V(BR)	75	-	V	IR=100uA
Forward Voltage	VF(1)	-	715	mV	IF=1mA
	VF(2)	-	855	mV	IF=10mA
	VF(3)	-	1000	mV	IF=50mA
	VF(4)	-	1250	mV	IF=150mA
Reverse Current	IR	-	1	uA	VR=75V
Total Capacitance	CT		2	pF	VR=0, f=1MHz
Reverse Recovery Time	Tr	-	6	nS	IF=IR=10mA, RL=100Ω measured at IR=1mA

### Characteristics Curve

